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ATTORNEY'S DOCKET NO.

TI-33535

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## APPLICATION FOR UNITED STATES PATENT DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I declare that my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor if only one name is listed below, or an original, first and joint inventor if plural inventors are named below, of the subject matter which is claimed and for which a patent is sought on the invention entitled as set forth below, which is described in the attached specification of Application Serial No. 10/001,302, filed 11/01/01; that I have reviewed and understand the contents of the specification, including the claims, as amended by any amendment specifically referred to in the oath or declaration; that no application for patent or inventor's certificate on this invention has been filed by me or my legal representatives or assigns in any country foreign to the United States of America; and that I acknowledge my duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56;

I trither declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be tall, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or infrisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

EFFLE OF INVENTION:		
12		
Bumpless Wafer Scale Device and Board Assembly		
POWER OF ATTORNEY: I HEREBY APPOINT PRACTITIONERS AT CUSTOMER NUMBER <b>23494</b> TO PROSECUTE THIS  APPLICATION AND TRANSACT ALL BUSINESS IN THE PATENT AND TRADEMARK OFFICE CONNECTED THEREWITH		
CONNECTED THEREWITH		
SEND CORRESPONDENCE TO:		DIRECT TELEPHONE CALLS TO:
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DATE: x \2/20/2001	DATE: x 12/20/2001	DATE: